3.3V ECL Quad Differential Receiver

Description

The MC100LVEL17 is a 3.3 V ECL, quad differential receiver. The device is functionally equivalent to the E116 device with the capability of operation from either a -3.3 V or +3.3 V supply voltage.

Under open input conditions, the \overline{D} input will be biased at $V_{CC}/2$ and the D input will be pulled down to V_{EE} . This operation will force the Q output LOW and ensure stability.

The V_{BB} pin, an internally generated voltage supply, is available to this device only. For single-ended input conditions, the unused differential input is connected to V_{BB} as a switching reference voltage. V_{BB} may also rebias AC coupled inputs. When used, decouple V_{BB} and V_{CC} via a 0.01 μF capacitor and limit current sourcing or sinking to 0.5 mA. When not used, V_{BB} should be left open.

Features

- 325 ps Propagation Delay
- High Bandwidth Output Transitions
- The 100 Series Contains Temperature Compensation
- PECL Mode Operating Range: V_{CC} = 3.0 V to 3.8 V with V_{EE} = 0 V
- NECL Mode Operating Range: V_{CC} = 0 V with V_{EE} = -3.0 V to -3.8 V
- Internal Input Pulldown Resistors D Inputs;
 Pullup and Pulldown on D Inputs
- Q Output will Default LOW with Inputs Open or at V_{EE}
- Pb-Free Packages are Available*



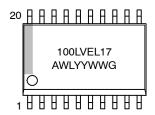
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SO-20 WB DW SUFFIX CASE 751D

MARKING DIAGRAM*



A = Assembly Location

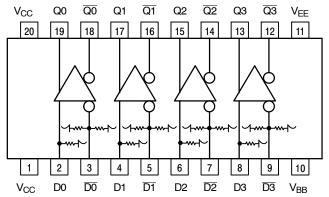
WL = Wafer Lot
YY = Year
WW = Work Week
G = Pb-Free Package

*For additional marking information, refer to Application Note AND8002/D.

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 5 of this data sheet.

^{*}For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.



* All V_{CC} pins are tied together on the die.

Warning: All $\rm V_{CC}$ and $\rm V_{EE}$ pins must be externally connected to Power Supply to guarantee proper operation.

Figure 1. Logic Diagram and Pinout: (Top View)

Table 1. PIN DESCRIPTION

PIN	FUNCTION
Dn, $\overline{\mathrm{D}}$ n	ECL Differential Data Inputs
Qn, Qn	ECL Differential Data Outputs
V _{BB}	Reference Voltage Output
V _{CC}	Positive Supply
V _{EE}	Negative Supply

Table 2. ATTRIBUTES

Characteri	Value	
Internal Input Pulldown Resistor	75 kΩ	
Internal Input Pullup Resistor	75 kΩ	
ESD Protection	> 2 kV > 200 V > 4 kV	
Moisture Sensitivity, (Note 1) Pb (Ir	Level 1 Level 3	
Flammability Rating	Oxygen Index: 28 to 34	UL 94 V-0 @ 0.125 in
Transistor Count		141
Meets or exceeds JEDEC Spec El	A/JESD78 IC Latchup Test	

^{1.} For additional information, see Application Note AND8003/D.

Table 3. MAXIMUM RATINGS

Symbol	Parameter	Condition 1	Condition 2	Rating	Unit
V _{CC}	PECL Mode Power Supply	V _{EE} = 0 V		8 to 0	V
V _{EE}	NECL Mode Power Supply	V _{CC} = 0 V		-8 to 0	V
VI	PECL Mode Input Voltage NECL Mode Input Voltage	V _{EE} = 0 V V _{CC} = 0 V	$\begin{aligned} & V_I \leq V_{CC} \\ & V_I \geq V_{EE} \end{aligned}$	6 to 0 -6 to 0	V V
l _{out}	Output Current	Continuous Surge		50 100	mA mA
I _{BB}	V _{BB} Sink/Source			± 0.5	mA
T _A	Operating Temperature Range			-40 to +85	°C
T _{stg}	Storage Temperature Range			-65 to +150	°C
$\theta_{\sf JA}$	Thermal Resistance (Junction-to-Ambient)	0 lfpm 500 lfpm	SO-20L SO-20L	90 60	°C/W °C/W
$\theta_{\sf JC}$	Thermal Resistance (Junction-to-Case)	Standard Board	SO-20L	30 to 35	°C/W
T _{sol}	Wave Solder Pb Pb-Free	<2 to 3 sec @ 248°C <2 to 3 sec @ 260°C		265 265	°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

Table 4. LVPECL DC CHARACTERISTICS V_{CC} = 3.3 V; V_{EE} = 0.0 V (Note 2)

			-40°C		25°C						
Symbol	Characteristic	Min	Тур	Max	Min	Тур	Max	Min	Тур	Max	Unit
I _{EE}	Power Supply Current		26	31		26	31		27	33	mA
V _{OH}	Output HIGH Voltage (Note 3)	2215	2295	2420	2275	2345	2420	2275	2345	2420	mV
V _{OL}	Output LOW Voltage (Note 3)	1470	1605	1745	1490	1595	1680	1490	1595	1680	mV
V _{IH}	Input HIGH Voltage (Single-Ended)			2420	2135		2420	2135		2420	mV
V _{IL}	Input LOW Voltage (Single-Ended)			1825	1490		1825	1490		1825	mV
V_{BB}	Output Voltage Reference			2.04	1.92		2.04	1.92		2.04	V
V _{IHCMR}	Input HIGH Voltage Common Mode Range (Differential) (Note 4)										
	Vpp < 500 mV	1.3		2.9	1.2		2.9	1.2		2.9	V
	Vpp ≧ 500 mV	1.5		2.9	1.4		2.9	1.4		2.9	V
I _{IH}	Input HIGH Current			150			150			150	μΑ
I _{IL}	Input LOW Current Dn	0.5			0.5			0.5			μΑ
	Dn	-300			-300			-300			μΑ

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

- Input and output parameters vary 1:1 with V_{CC}. V_{EE} can vary ±0.3 V.
 Outputs are terminated through a 50 Ω resistor to V_{CC} 2.0 V.
 V_{IHCMR} min varies 1:1 with V_{EE}, max varies 1:1 with V_{CC}. The V_{IHCMR} range is referenced to the most positive side of the differential input signal. Normal operation is obtained if the HIGH level falls within the specified range and the peak-to-peak voltage lies between V_{PP}min and 1 V.

Table 5. LVNECL DC CHARACTERISTICS $V_{CC} = 0.0 \text{ V}$; $V_{EE} = -3.3 \text{ V}$ (Note 5)

		-40°C			25°C						
Symbol	Characteristic	Min	Тур	Max	Min	Тур	Max	Min	Тур	Max	Unit
I _{EE}	Power Supply Current		26	31		26	31		27	33	mA
V _{OH}	Output HIGH Voltage (Note 6)	-1085	-1005	-880	-1025	-955	-880	-1025	-955	-880	mV
V _{OL}	Output LOW Voltage (Note 6)		-1695	-1555	-1810	-1705	-1620	-1810	-1705	-1620	mV
V _{IH}	Input HIGH Voltage (Single-Ended)			-880	-1165		-880	-1165		-880	mV
V _{IL}	Input LOW Voltage (Single-Ended)			-1475	-1810		-1475	-1810		-1475	mV
V_{BB}	Output Voltage Reference	-1.38		-1.26	-1.38		-1.26	-1.38		-1.26	V
V _{IHCMR}	Input HIGH Voltage Common Mode Range (Differential) (Note 7)										
	Vpp < 500 mV	-2.0		-0.4	-2.1		-0.4	-2.1		-0.4	V
	Vpp ≧ 500 mV	-1.8		-0.4	-1.9		-0.4	-1.9		-0.4	V
I _{IH}	Input HIGH Current			150			150			150	μΑ
I _{IL}	Input LOW Current Dn	0.5			0.5			0.5			μΑ
	Dn	-300			-300			-300			μΑ

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

- 5. Input and output parameters vary 1:1 with $V_{CC}.\ V_{EE}$ can vary $\pm 0.3\ V.$
- 6. Outputs are terminated through a 50 Ω resistor to V_{CC} 2.0 V.

 7. V_{IHCMR} min varies 1:1 with V_{EE} , max varies 1:1 with V_{CC} . The V_{IHCMR} range is referenced to the most positive side of the differential input signal. Normal operation is obtained if the HIGH level falls within the specified range and the peak-to-peak voltage lies between Vppmin and 1 V.

Table 6. AC CHARACTERISTICS $V_{CC} = 3.3 \text{ V}$; $V_{EE} = 0.0 \text{ V}$ or $V_{CC} = 0.0 \text{ V}$; $V_{EE} = -3.3 \text{ V}$ (Note 8)

			-40°C			25°C						
Symbol	Characteristic		Min	Тур	Max	Min	Тур	Max	Min	Тур	Max	Unit
f _{max}	Maximum Toggle Frequency						1.75					GHz
t _{PLH} t _{PHL}	Propagation Delay D to Q	Diff S.E.	330 280		530 580	350 300		550 600	360 310		560 610	ps
t _{SKEW}	Skew Output-to-Output (No Part-to-Part (Diff) (No Duty Cycle (Diff) (Note	te 9)			75 200 25			75 200 25			75 200 25	ps
t _{JITTER}	Random Clock Jitter (RMS)						0.7					ps
V _{PP}	Input Swing (Note 11)		150		1000	150		1000	150		1000	mV
t _r	Output Rise/Fall Times Q (20% – 80%)		280		550	280		550	280		550	ps

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

- 8. V_{EE} can vary ±0.3 V.
- 9. Skews are valid across specified voltage range, part-to-part skew is for a given temperature.
- 10. Duty cycle skew is the difference between a t_{PLH} and t_{PHL} propagation delay through a device.
- 11. V_{PP} (min) is minimum input swing for which AC parameters guaranteed. The device has a DC gain of \approx 40.

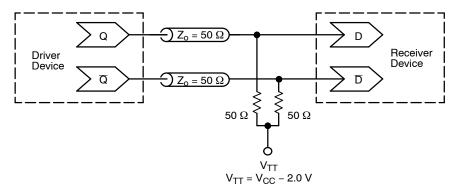


Figure 2. Typical Termination for Output Driver and Device Evaluation (See Application Note AND8020/D – Termination of ECL Logic Devices.)

ORDERING INFORMATION

Device	Package	Shipping [†]
MC100LVEL17DW	SO-20 WB	38 Units / Rail
MC100LVEL17DWG	SO-20 WB (Pb-Free)	38 Units / Rail
MC100LVEL17DWR2	SO-20 WB	1000 / Tape & Reel
MC100LVEL17DWR2G	SO-20 WB (Pb-Free)	1000 / Tape & Reel

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

Resource Reference of Application Notes

AN1405/D - ECL Clock Distribution Techniques

AN1406/D – Designing with PECL (ECL at +5.0 V)

AN1503/D – ECLinPS™ I/O SPiCE Modeling Kit

AN1504/D - Metastability and the ECLinPS Family

AN1568/D - Interfacing Between LVDS and ECL

AN1672/D - The ECL Translator Guide

AND8001/D - Odd Number Counters Design

AND8002/D - Marking and Date Codes

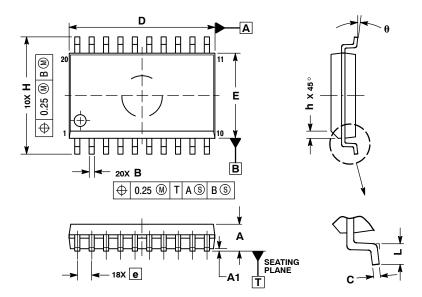
AND8020/D - Termination of ECL Logic Devices

AND8066/D - Interfacing with ECLinPS

AND8090/D - AC Characteristics of ECL Devices

PACKAGE DIMENSIONS

SO-20 WB DW SUFFIX CASE 751D-05 ISSUE G



NOTES

- 1. DIMENSIONS ARE IN MILLIMETERS.
 2. INTERPRET DIMENSIONS AND TOLERANCES
 PER ASME Y14.5M, 1994.
- DIMENSIONS D AND E DO NOT INCLUDE MOLD PROTRUSION.
- MAXIMUM MOLD PROTRUSION 0.15 PER SIDE.
 DIMENSION B DOES NOT INCLUDE DAMBAR
- PROTRUSION. ALLOWABLE PROTRUSION
 SHALL BE 0.13 TOTAL IN EXCESS OF B
 DIMENSION AT MAXIMUM MATERIAL
 CONDITION.

	MILLIMETERS							
DIM	MIN	MAX						
Α	2.35	2.65						
A1	0.10	0.25						
В	0.35	0.49						
С	0.23	0.32						
D	12.65	12.95						
Е	7.40	7.60						
е	1.27	BSC						
Н	10.05	10.55						
h	0.25	0.75						
L	0.50	0.90						
θ	0 °	7 °						

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